

## UM11077 TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board Rev. 1 — 16 April 2018 User manual

#### **Document information**

| Information | Content  |
|-------------|--|
| Keywords    | TEA1936xDB1533, TEA1936x universal serial bus, power delivery, USB-PD, quick charge QC 4.0, USB-PD 2.0, and 3.0, type-C  |
| Abstract    | This user manual describes the performance, technical data, and the connections of the TEA1936xDB1533 demo board. The TEA1936xDB1533 demo board operates at mains voltages from 90 V (AC) up to 264 V (AC) with an output voltage from 5 V (DC) up to 20 V (DC). |



## TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board

#### Revision history

| Rev | Date     | Description |
|-----|----------|-------------|
| v.1 | 20180416 | first issue |

## **1** Introduction

#### Warning

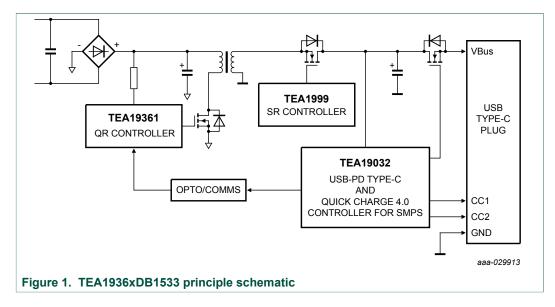


The non-insulated high voltages that are present when operating this product, constitute a risk of electric shock, personal injury, death and/or ignition of fire. This product is intended for evaluation purposes only. It shall be operated in a designated test area by personnel qualified according to local requirements and labor laws to work with non-insulated mains voltages and high-voltage circuits. This product shall never be operated unattended.

This user manual describes the operation of the TEA1936xDB1533 demo board. The TEA1936xDB1533 features the quasi-resonant controller TEA19361, the synchronous rectifier controller TEA1999, and the USB-PD Type-C and QC 4.0 controller TEA19032.

The TEA1936xDB1533 demo board is designed for delivering a maximum output power of 45 W at a maximum current of 3 A. Output voltages can be chosen from 5 V up to 20 V.

The TEA1936xDB1533 provides an effective solution with a low current ripple and high efficiency for USB-PD and quick charge applications.



UM11077

3/22

### 1.1 Key features

- Multi-protocol support for USB-PD 2.0 and 3.0, Quick Charge 4.0
- Functionality user-configurable end of line
- · Best-in-class energy efficiency meeting all DOE & EU CoC requirements
- < 30 mW no-load power, low audible noise, low output voltage ripple
- Small size due to high near-full digital integration level and > 15.9 W/CI power density
- Best-in-class Thermal management
- · Safe solution with extensive set of hardware-integrated protection features
- Complete one-stop-shop solution from NXP Semiconductors minimizing development time and research and development cost

### 1.2 Applications

Mobile chargers with Type-C connector for:

- Mobile phones
- Smart phones
- Tablets
- Notebooks

The new smart charger platform of NXP Semiconductors helps designers of travel adapters to maximize power output for the smallest form-factor with a short bill of materials.

The result is a cost-effective design. It meets the requirements published by Energy Star, the Department of Energy (DoE) in the United States, the Ecodesign Directive of the European Union, the European Code of Conduct, and other guidelines.

Supporting hardware (UTC) and software (GUI) for USB-PD available for jump-starting application.

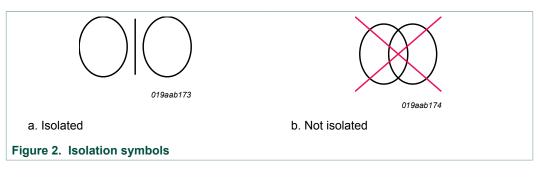
UM11077

#### TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board

## 2 Safety warning

The TEA1936xDB1533 demo board is connected to the mains voltage. Avoid touching the board while it is connected to the mains voltage and when it is in operation. An isolated housing is obligatory when used in uncontrolled, non-laboratory environments. Galvanic isolation from the mains phase using a fixed or variable transformer is always recommended.

Figure 2 shows the symbols on how to recognize these devices.



## 3 Specifications

#### Table 1. TEA1936xDB1533 specifications

| Symbol                     | Parameter                                     | Value                            |
|----------------------------|---|----------------------------------|
| V <sub>mains</sub>         | AC mains voltage                              | 90 V (AC) up to 264 V (AC)       |
| P <sub>out(max)</sub>      | maximum output power                          | 45 W                             |
| f <sub>mains</sub>         | mains frequency                               | 47 Hz to 63 Hz                   |
| P <sub>idle</sub>          | no-load input power                           | < 30 mW                          |
| η                          | efficiency                                    | > 92 %; at P <sub>out(max)</sub> |
| V <sub>out</sub>           | output voltage                                | 5 V (DC) to 20 V (DC)            |
| I <sub>out(max)</sub>      | maximum output current                        | 3 A                              |
| V <sub>ripple(burst)</sub> | output voltage ripple in burst mode           | 100 mV (p-p); at cable end       |
| V <sub>ripple(full)</sub>  | output voltage ripple at continuous switching | 80 mV (p-p); at cable end        |
| EMI                        | conducted EMI                                 | -7 dB                            |
| CMN                        | common-mode noise                             | < 2 V (p-p)                      |
| ESD                        | electrostatic discharge                       | ±15 kV; through air              |
|                            |   | ±8 kV; via contact               |

UM11077 User manual

#### TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board

## 4 Board photographs





Figure 4. TEA1936xDB1533

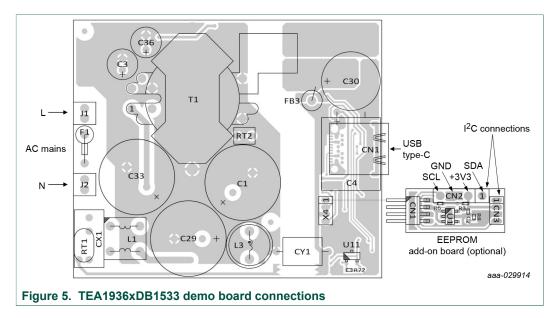


b. Bottom view

#### TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board

## 5 TEA1936xDB1533 demo board connections

The TEA1936xDB1533 demo board is a universal mains supplied application. The output is the Type-C receptacle. Setting the output voltage is done through the USB type-C interface. Additionally, the TEO II graphical user interface software provides the option to program other output voltages and limit currents into the TEA19032 PD controller IC. <u>Section 7</u> lists the default settings.



## 6 TEA1936xDB1533 demo board performance

## 6.1 Efficiency

Table 2. Efficiency at 5 V output (PCB end)

| Load            | Efficiency at<br>115 V (AC)(%) | Efficiency at<br>230 V (AC)(%) |
|-----------------|--------------------------------|--------------------------------|
| 10 % (0.3 A)    | 87.8                           | 84.4                           |
| 25 % (0.75 A)   | 88.6                           | 85.7                           |
| 50 % (1.5 A)    | 89.3                           | 86.6                           |
| 75 % (2.25 A)   | 90                             | 86.9                           |
| 100 % (3 A)     | 90.1                           | 88.9                           |
| 4-point average | 89.5                           | 87                             |

#### Table 3. Efficiency at 9 V output (PCB end)

| Load            | Efficiency at<br>115 V (AC)(%) | Efficiency at<br>230 V (AC)(%) |
|-----------------|--------------------------------|--------------------------------|
| 10 % (0.3 A)    | 88.5                           | 86.1                           |
| 25 % (0.75 A)   | 90.0                           | 87.6                           |
| 50 % (1.5 A)    | 91.2                           | 89.0                           |
| 75 % (2.25 A)   | 92.5                           | 90.7                           |
| 100 % (3 A)     | 92.4                           | 92.1                           |
| 4-point average | 91.5                           | 89.8                           |

#### Table 4. Efficiency at 15 V output (PCB end)

| Load            | Efficiency at<br>115 V (AC)(%) | Efficiency at<br>230 V (AC)(%) |
|-----------------|--------------------------------|--------------------------------|
| 10 % (0.3 A)    | 86.5                           | 84.8                           |
| 25 % (0.75 A)   | 88.8                           | 87.7                           |
| 50 % (1.5 A)    | 91.8                           | 90.5                           |
| 75 % (2.25 A)   | 93.2                           | 92.0                           |
| 100 % (3 A)     | 92.9                           | 93.0                           |
| 4-point average | 91.7                           | 90.8                           |

 Table 5. Efficiency at 20 V output (PCB end)

| Load            | Efficiency at<br>115 V (AC)(%) | Efficiency at<br>230 V (AC)(%) |
|-----------------|--------------------------------|--------------------------------|
| 10 % (0.23 A)   | 86.1                           | 84.2                           |
| 25 % (0.575 A)  | 88.9                           | 87.5                           |
| 50 % (1.15 A)   | 91.8                           | 89.9                           |
| 75 % (1.725 A)  | 92.8                           | 92.3                           |
| 100 % (2.3 A)   | 93.0                           | 92.8                           |
| 4-point average | 91.6                           | 90.6                           |

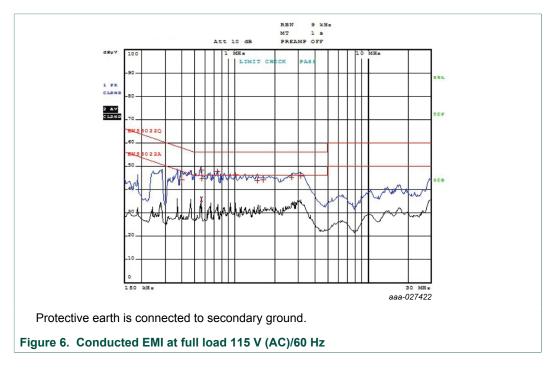
## 6.2 No-load power consumption at 5 V output

#### Table 6. No-load power consumption

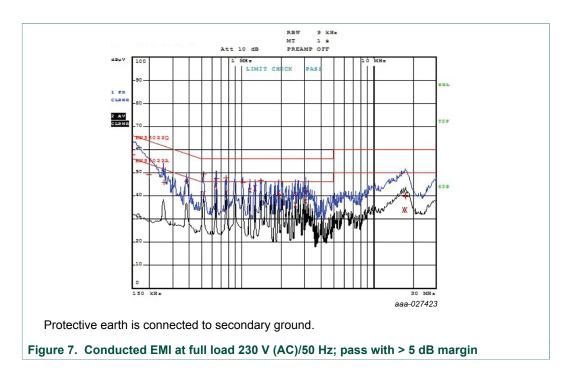
*Type-C cable disconnected.* 

| Input voltage (V (AC)) | Input frequency (Hz) | No-load power (mW) |
|------------------------|----------------------|--------------------|
| 90                     | 60                   | 21.1               |
| 115                    | 60                   | 21.6               |
| 150                    | 60                   | 22.2               |
| 180                    | 50                   | 22.3               |
| 200                    | 50                   | 22.9               |
| 230                    | 50                   | 23.9               |
| 264                    | 50                   | 28.4               |

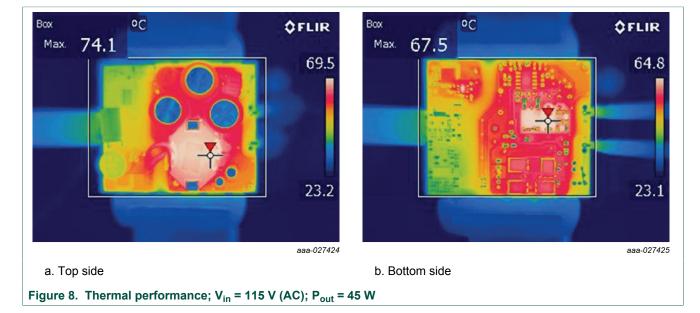
TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board



## 6.3 ElectroMagnetic Interference (EMI)



#### TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board



### 6.4 Thermal

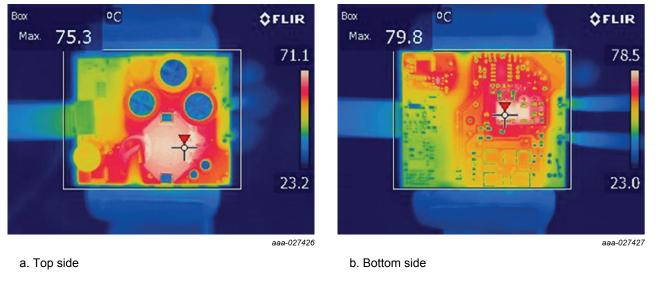


Figure 9. Thermal performance; V<sub>in</sub> = 230 V (AC); P<sub>out</sub> = 45 W

**Note:** Typical temperature distribution at  $T_{amb} = 25$  °C; PCB in free air, natural convection, and radiation only. For the TEA1936xDB1533 demo board, the voltage levels must not exceed 20 V also. Current limit levels must not exceed 3 A. Power limit levels must not exceed 45 W.

## 7 PDO settings

<u>Table 7</u> shows the settings of the output voltages and currents for the efficiency measurement.

#### Table 7. PDO settings

Default values for demo board TEA1936xDB1533

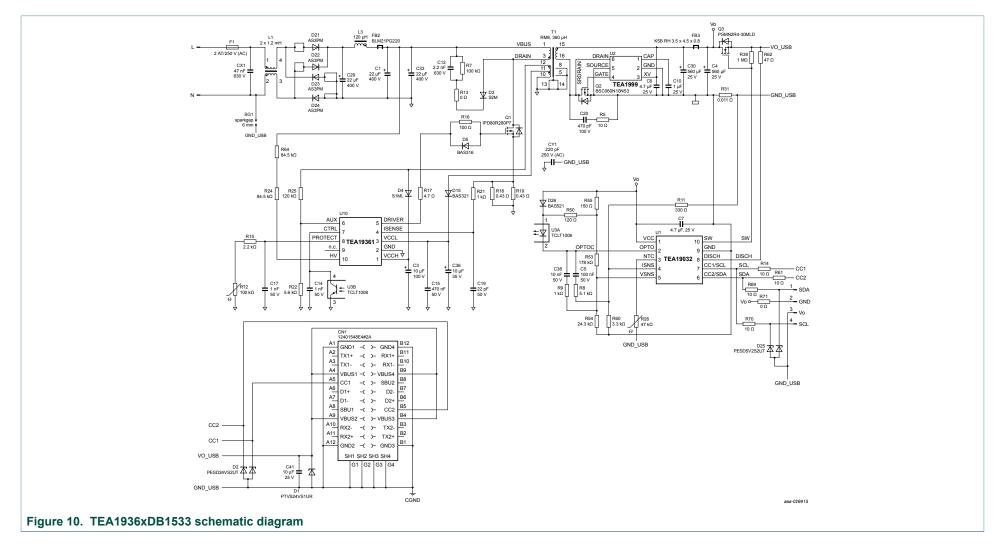
| PDO (#) | V <sub>out</sub> (V) | I <sub>out</sub> (A) |
|---------|----------------------|----------------------|
| 1       | 5                    | 3                    |
| 2       | 9                    | 3                    |
| 3       | 15                   | 3                    |
| 4       | 20                   | 2.3                  |

PDO settings can be changed by reprogramming the MTP settings of the TEA19032 via UTC using the TEO-II software (see the TEA190x Evaluation Overdrive (TEO) user manual (Ref. 1).

**Note:** The PDOs must have an ascending voltage and power in order to work correctly. So, V(PDO, i + 1) > V(PDO, i) and also P(PDO, i + 1) > P(PDO, i). Also, for the TEA1936xDB1533 demo board, the voltage levels must not exceed 20 V. Current limit levels must not exceed 3 A. Power limit levels must not exceed 45 W.

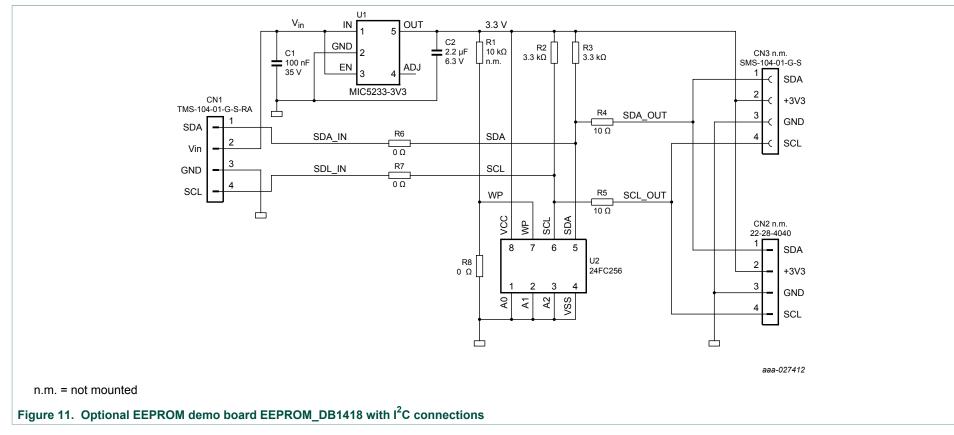
## 8 Schematic

The schematic of the TEA1936xDB1533 comprises the TEA19361 quasi-resonant controller, the TEA1999 synchronous rectifier controller, and the TEA19032 USB-PD/QC controller.



## UM11077

#### TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board



## 9 Bill Of Materials (BOM)

| Reference             | Description and values                                 | Part Number                  | Manufacturer                  |
|-----------------------|--|------------------------------|-------------------------------|
| C1                    | capacitor; 22 µF; 20 %; 400 V; ALU; D13xL17mm          | EKM226M2GJ17RR               | SAMXON                        |
| C3                    | capacitor; 10 µF; 20 %; 100 V; ALU; THT                | 100YXJ10M5X11                | Rubycon                       |
| C4                    | capacitor; 560 µF; 20 %; 25 V; ALU; THT                | A750MS567M1EAAE015           | KEMET                         |
| C5                    | capacitor; 100 nF; 10 %; 50 V; X7R; 0402               | C1005X7R1H104K050BB          | TDK                           |
| C6                    | capacitor; 4.7 µF; 10 %; 25 V; X5R; 0603               | C1608X5R1E475K080AC          | TDK                           |
| C7                    | capacitor; 4.7 µF; 10 %; 16 V; X5R; 0603               | C1608X5R1C475K080AC          | TDK                           |
| C10                   | capacitor; 1 µF; 10 %; 25 V; X7R; 0603                 | -                            | -                             |
| C12                   | capacitor; 2200 pF; 10 %; 630 V; X7R; 1206             | C1206C222KBRAC               | KEMET                         |
| C14                   | capacitor; 1 nF; 10 %; 50 V; X7R; 0603                 | -                            | -                             |
| C15                   | capacitor; 470 nF; 10 %; 50 V; X7R; 0603               | C1608X7R1H474K               | TDK                           |
| C17                   | capacitor; 1 nF; 10 %; 50 V; X7R; 0603                 | -                            | -                             |
| C19                   | capacitor; 22 pF; 5 %; 50 V; C0G; 0603                 | -                            | -                             |
| C20                   | capacitor; 470 pF; 10 %; 100 V; X7R; 0603              | -                            | -                             |
| C29                   | capacitor; 22 µF; 20 %; 400 V; ALU; D13xL17mm          | EKM226M2GJ17RR               | SAMXON                        |
| C30                   | capacitor; 560 µF; 20 %; 25 V; ALU; THT                | A750MS567M1EAAE015           | KEMET                         |
| C33                   | capacitor; 22 µF; 20 %; 400 V; ALU; D13xL17mm          | EKM226M2GJ17RR               | SAMXON                        |
| C36                   | capacitor; 10 µF; 20 %; 35 V; ALU; THT                 | UVR1V100MDD6TP               | Nichicon                      |
| C38                   | capacitor; 10 nF; 10 %; 50 V; X7R; 0402                | -                            | -                             |
| C41                   | capacitor; 10 µF; 10 %; 25 V; X5R; 0603                | C1608X5R1E106M080            | TDK                           |
| CN1                   | Connector; USB 3.1 Type-C receptacle R/A               | 12401548E4#2A                | Amphenol                      |
| CY1                   | capacitor; 220 pF; 10 %; 250 V (AC); B; THT; X1/<br>Y2 | DE2B3KY221KA2BM01F           | Murata                        |
| D1                    | diode; TVS; unidirectional; 24 V; 400 W                | PTVS24VS1UR                  | NeXPeria USA Inc              |
| D2                    | diode; ESD protection; 24 V; 3 A                       | PESD24VS2UT                  | NeXPeria USA Inc              |
| D3                    | diode; 1 kV; 2 A                                       | S2M                          | Fairchild                     |
| D4                    | diode; 1 kV; 1 A                                       | S1ML                         | Taiwan Semiconductor          |
| D5                    | diode; 100 V; 250 mA                                   | BAS316                       | NeXPeria USA Inc              |
| D15                   | diode; 200 V; 250 mA                                   | BAS321                       | NeXPeria USA Inc              |
| D21; D22;<br>D23; D24 | diode; 1 kV; 3 A                                       | AS3PM-M3/86A                 | Vishay                        |
| D25                   | diode; ESD protection; 30 kV; 3 A                      | PESD5V2S2UT                  | NXP Semiconductors            |
| D26                   | diode; 300 V; 250 mA                                   | BAS521                       | NeXPeria USA Inc              |
| F1                    | fuse; slow blow; 250 V; 2 A                            | MCPMP2A250V                  | Multicomp                     |
| FB2                   | ferrite bead; 0.009 Ω; 6 A; 0805                       | BLM21PG220SH1D               | Murata                        |
| FB3                   | ferrite bead; K5B RH 3.5 × 4.5 × 0.8                   | K5B RH 3.5 x 4.5 x 0.8 - T52 | King Core Electronics<br>Inc. |

UM11077

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# UM11077

### TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board

| Reference | Description and values                        | Part Number        | Manufacturer       |
|-----------|---|--------------------|--------------------|
| L1        | inductor CM; 2 ×1.2 mH; Cu = 0.27 mm; 18T:18T | T8x4x4 H5C3        | TDK                |
| L3        | inductor; 120 μH; 850 mA; 0.22 Ω              | 744772121          | Würth Elektronik   |
| Q1        | MOSFET-N; 800 V; 0.28 Ω; 17 A                 | IPD80R280P7ATMA1   | Infineon           |
| Q2        | MOSFET-N; 100 V; 90 A; 0.006 Ω; TDSON         | BSC060N10NS3GATMA1 | Infineon           |
| Q3        | MOSFET-N; 30 V; 2.4 mΩ; 70 A                  | PSMN2R4-30MLD      | NeXPeria USA Inc   |
| R5        | resistor; 10 Ω; 1 %; 63 mW; 0603              | -                  | -                  |
| R7        | resistor; 100 kΩ; 1 %; 660 mW; 1206           | ERJP08F1003V       | Panasonic          |
| R8        | resistor; 5.1 kΩ; 1 %; 63 mW; 0402            | -                  | -                  |
| R9        | resistor; 1 kΩ; 1 %; 63 mW; 0402              | -                  | -                  |
| R11       | resistor; 330 Ω; 1 %; 63 mW; 0402             | -                  | -                  |
| R13       | resistor; jumper; 0 Ω; 250 mW; 1206           | -                  | -                  |
| R14; R61  | resistor; 10 Ω; 1 %; 100 mW; 0402             | ERJ2RKF10R0X       | Panasonic          |
| R15       | resistor; 2.2 kΩ; 1 %; 63 mW; 0603            | -                  | -                  |
| R16       | resistor; 100 Ω; 1 %; 100 mW; 0603            | -                  | -                  |
| R17       | resistor; 4.7 Ω; 1 %; 100 mW; 0603            | -                  | -                  |
| R18; R19  | resistor; 0.43 Ω; 1 %; 250 mW; 0805           | ERJS6QFR43V        | Panasonic          |
| R21       | resistor; 1 kΩ; 1 %; 63 mW; 0603              | -                  | -                  |
| R22       | resistor; 5.6 kΩ; 1 %; 63 mW; 0603            | -                  | -                  |
| R24       | resistor; 84.5 kΩ; 1 %; 660 mW; 500 V; 1206   | ERJP08F8452V       | Panasonic          |
| R25       | resistor; 120 kΩ; 1 %; 250 mW; 250 V; 0603    | ERJPA3F1203V       | Panasonic          |
| R26       | resistor; NTC; 47 kΩ; 5 %; 180 mW; 3980 K     | B57321V2473J060    | EPCOS              |
| R31       | resistor; 0.011 Ω; 1 %; 1 W; 1206             | ERJ8CWFR011V       | Panasonic          |
| R39       | resistor; 1 MΩ; 1 %; 63 mW; 0402              | CRCW04021M00FKED   | Vishay             |
| R50       | resistor; 120 Ω; 1 %; 100 mW; 0402            | ERJ2RKF1200X       | Panasonic          |
| R53       | resistor; 178 kΩ; 1 %; 63 mW; 0402            | -                  | -                  |
| R54       | resistor; 24.3 kΩ; 1 %; 63 mW; 0402           | -                  | -                  |
| R55       | resistor; 150 Ω; 1 %; 100 mW; 0402            | ERJ2RKF1500X       | Panasonic          |
| R60       | resistor; 3.3 kΩ; 1 %; 63 mW; 0402            | -                  | -                  |
| R62       | resistor; 47 Ω; 1 %; 500 mW; 0805             | ERJP6WF47R0V       | Panasonic          |
| R64       | resistor; 84.5 kΩ; 1 %; 660 mW; 500 V; 1206   | ERJP08F8452V       | Panasonic          |
| R69; R70  | resistor; 10 Ω; 1 %; 100 mW; 0402             | ERJ2RKF10R0X       | Panasonic          |
| R71       | resistor; jumper; 0 $\Omega$ ; 100 mW; 0402   | ERJP6WF47R0V       | Panasonic          |
| RT2       | resistor; NTC; 100 kΩ; 5 %; 100 mW; 4190 K    | NTCLE100E3104JB0   | Vishay             |
| T1        | Transformer; RM8; 360 µH                      | RM8 (TR1083)       | NXP Semiconductors |
| U1        | USB-PD controller                             | TEA19032 (SO10)    | NXP Semiconductors |
| U2        | synchronous rectification controller          | TEA1999            | NXP Semiconductors |
| U10       | SMPS controller                               | TEA19361           | NXP Semiconductors |

### TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board

| Reference | Description and values        | Part Number | Manufacturer |
|-----------|-------------------------------|-------------|--------------|
| U3        | optocoupler; NPN; 70 V; 50 mA | TCLT1008    | Vishay       |

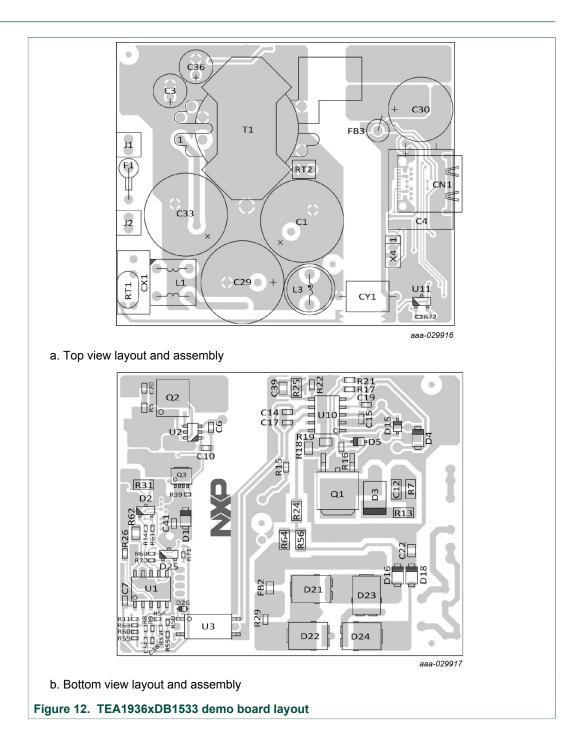
#### Table 9. EEPROM\_DB1418 bill of materials

| Reference  | Description and values                                   | Part Number        | Manufacturer |
|------------|--|--------------------|--------------|
| C1         | capacitor; 100 nF; 10 %; 35 V; X7R; 0402                 | -                  | -            |
| C2         | capacitor; 2.2 μF; 20 %; 6.3 V; X5R; 0402                | GRM155R60J225ME15D | Murata       |
| CN1        | header; right angle; 1 × 4-way; 1.27 mm                  | TMS-104-01-G-S-RA  | SAMTEC       |
| CN2        | header; not mounted; straight; 1 × 4-way;<br>2.54 mm     | 22-28-4040         | Molex        |
| CN3        | receptacle; not mounted; straight; 1 × 4-way;<br>1.27 mm | SMS-104-01-G-S     | SAMTEC       |
| R1         | resistor; not mounted; 10 k $\Omega$ ; 1 %; 63 mW; 0402  | CRCW040210K0FKED   | Vishay       |
| R2         | resistor; 3.3 kΩ; 1 %; 63 mW; 0402                       | CRCW04023K30FKED   | Vishay       |
| R3         | resistor; 3.3 kΩ; 1 %; 63 mW; 0402                       | CRCW04023K30FKED   | Vishay       |
| R4         | resistor; 10 Ω; 1 %; 200 mW; 0402                        | ERJ-PA2F10R0X      | Panasonic    |
| R5         | resistor; 10 Ω; 1 %; 200 mW; 0402                        | ERJ-PA2F10R0X      | Panasonic    |
| R6; R7; R8 | resistor; jumper; 0 Ω; 63 mW; 0402                       | CRCW04020000Z0ED   | Vishay       |
| U1         | LDO; 3.3 V   | MIC5233-3.3YM5 TR  | MICREL       |
| U2         | EEPROM; 256 kb; I <sup>2</sup> C; CMOS                   | 24FC256-I/SN       | Microchip    |

# UM11077

#### TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board

## 10 Layout

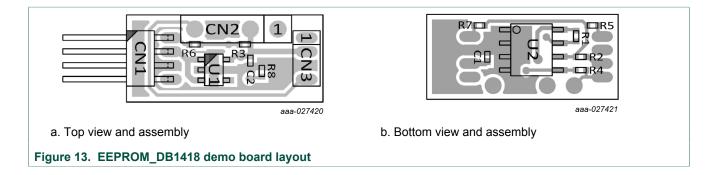


User manual

UM11077

# UM11077

### TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board



### TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board

## **11 Abbreviations**

| Table 10. Abbreviations |                              |  |  |  |
|-------------------------|------------------------------|--|--|--|
| Acronym                 | Description                  |  |  |  |
| USB                     | Universal Serial Bus         |  |  |  |
| PD                      | Power Delivery               |  |  |  |
| QC                      | Quick Charge                 |  |  |  |
| UTC                     | Universal Type-C Controller  |  |  |  |
| PDO                     | Power Data Object            |  |  |  |
| MTP                     | Multiple Times Programmable  |  |  |  |
| TEO                     | TEA190x Evaluation Overdrive |  |  |  |

## 12 References

1 UM11014 user manual

TEA190x Evaluation Overdrive (TEO); 2017, NXP Semiconductors

#### TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board

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## 13.1 Definitions

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### TEA1936xDB1533 45 W USB-PD and QC 4.0 demo board

## Contents

| 1   | Introduction          |                                       |           | 3    |
|-----|-----------------------|---------------------------------------|-----------|------|
| 1.1 | Key features          |                                       |           | 4    |
| 1.2 | Applications          |                                       |           |      |
| 2   | Safety warning        |                                       |           | 5    |
| 3   | Specifications        |                                       |           |      |
| 4   | Board photographs     |                                       |           | 6    |
| 5   | TEA1936xDB1533 der    | no board co                           | nnections | 7    |
| 6   | TEA1936xDB1533        | demo                                  | board     |      |
|     | performance           |                                       |           | 8    |
| 6.1 | Efficiency            |                                       |           | 8    |
| 6.2 | No-load power consu   | umption at 5                          | √ output  | 9    |
| 6.3 | ElectroMagnetic Inte  | rference (EM                          | I)        | . 10 |
| 6.4 | Thermal               | · · · · · · · · · · · · · · · · · · · | ,<br>     | .11  |
| 7   | PDO settings          |                                       |           | 12   |
| 8   | Schematic             |                                       |           | 13   |
| 9   | Bill Of Materials (BO | M) (N                                 |           | .15  |
| 10  | Layout                |                                       |           | .18  |
| 11  | Abbreviations         |                                       |           | 20   |
| 12  | References            |                                       |           | . 20 |
| 13  | Legal information     |                                       |           | .21  |

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